

Static Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
$V_{(BR)DSS}$	Drain-to-Source Breakdown Voltage	-30			V	$V_{GS} = 0V, I_{D} = -250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient		0.022		V/°C	Reference to 25°C, I _D = -1mA
D	Static Drain-to-Source On-Resistance		0.042	0.058	Ω	$V_{GS} = -10V, I_D = -4.9A \oplus$
R _{DS(on)}	Static Dialif-to-Source Off-nesistatice		0.076	0.098	\$2	$V_{GS} = -4.5V, I_D = -3.6A$
$V_{GS(th)}$	Gate Threshold Voltage	-1.0		-3.0	V	$V_{DS} = V_{GS}$, $I_D = -250\mu A$
gfs	Forward Transconductance		7.7		S	$V_{DS} = -15V, I_{D} = -4.9A$
I _{DSS}	Drain-to-Source Leakage Current			-1.0		$V_{DS} = -24V, V_{GS} = 0V$
				-25	μA	$V_{DS} = -24V, V_{GS} = 0V, T_{J} = 55^{\circ}C$
I _{GSS}	Gate-to-Source Forward Leakage			100	nA	$V_{GS} = -20V$
	Gate-to-Source Reverse Leakage			-100	IIA	$V_{GS} = 20V$

Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
Q_g	Total Gate Charge		23	34		$I_D = -4.9A$
Q_{gs}	Gate-to-Source Charge		3.8	5.7	nC	$V_{DS} = -15V$
Q_{gd}	Gate-to-Drain ("Miller") Charge		5.9	8.9	Ī	$V_{GS} = -10V$, See Fig.10 \oplus
t _{d(on)}	Turn-On Delay Time		13	19		$V_{DD} = -15V$
t _r	Rise Time		13	20		$I_{D} = -1.0A$
t _{d(off)}	Turn-Off Delay Time		34	51	ns	$R_G = 6.0\Omega$
t _f	Fall Time		32	48	Ī	$R_D = 15\Omega$ ④
C _{iss}	Input Capacitance		710			$V_{GS} = 0V$
C _{oss}	Output Capacitance		380		рF	$V_{DS} = -25V$
C _{rss}	Reverse Transfer Capacitance		180		Ī	f = 1.0MHz,See Fig.5

Diode Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions
Is	Continuous Source Current			-2.5		MOSFET symbol
	(Body Diode)			-2.5	Α	showing the
I _{SM}	Pulsed Source Current			20	_ ^	integral reverse
	(Body Diode) ①			-30		p-n junction diode.
V_{SD}	Diode Forward Voltage		-0.78	-1.0	V	$T_J = 25^{\circ}C, I_S = -1.7A, V_{GS} = 0V $
t _{rr}	Reverse Recovery Time		44	66	ns	$T_J = 25^{\circ}C, I_F = -1.7A$
Q _{rr}	Reverse Recovery Charge		42	63	nC	di/dt = 100A/µs④

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11) ② Starting $T_J = 25^{\circ}\text{C}$, L = 35mH, $R_G = 25\Omega$, $I_{AS} = -2.8\text{A}$. ③ $I_{SD} \le -2.8\text{A}$, $di/dt \le 150\text{A}/\mu\text{s}$, $V_{DD} \le V_{(BR)DSS}$, $T_J \le 150^{\circ}\text{C}$ ④ Pulse width $\le 300\mu\text{s}$, duty cycle $\le 2\%$.

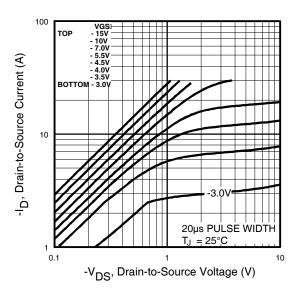


Fig 1. Typical Output Characteristics

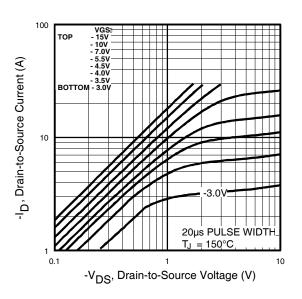


Fig 2. Typical Output Characteristics

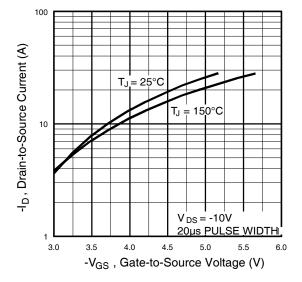


Fig 3. Typical Transfer Characteristics

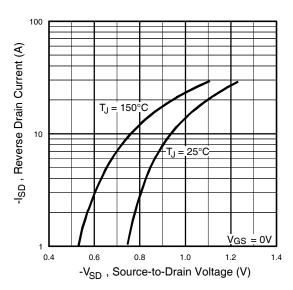


Fig 4. Typical Source-Drain Diode Forward Voltage

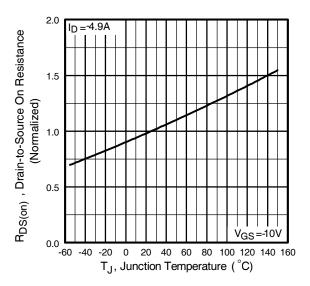


Fig 5. Normalized On-Resistance Vs. Temperature

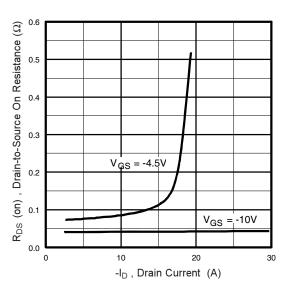


Fig 6. Typical On-Resistance Vs. Drain Current

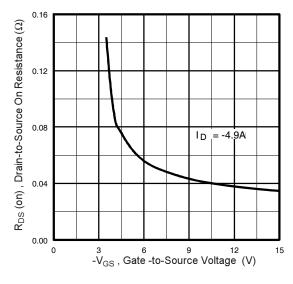


Fig 7. Typical On-Resistance Vs. Gate Voltage

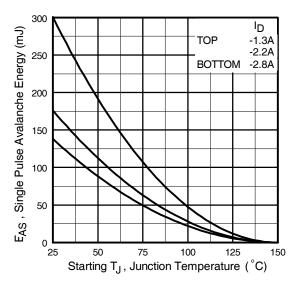
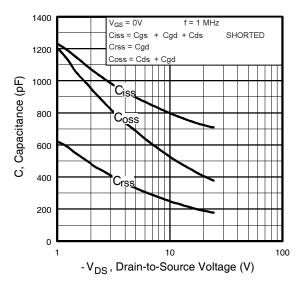


Fig 8. Maximum Avalanche Energy Vs. Drain Current





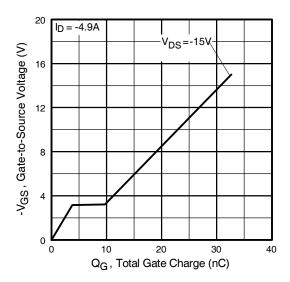


Fig 9. Typical Capacitance Vs. Drain-to-Source Voltage

Fig 10. Typical Gate Charge Vs. Gate-to-Source Voltage

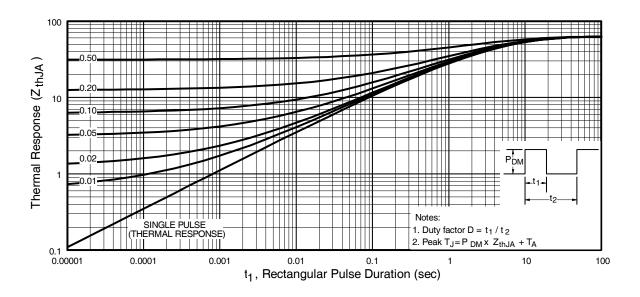
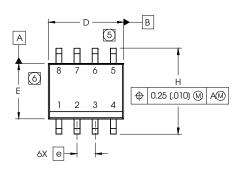


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

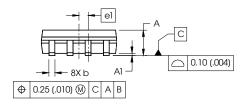


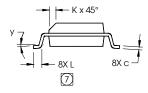
SO-8 Package Outline

Dimensions are shown in millimeters (inches)



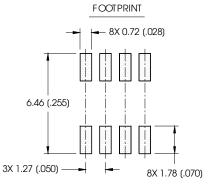
DIM	INC	HES	MILLIMETERS			
DIIVI	MIN	MAX	MIN	MAX		
Α	.0532	.0688	1.35	1.75		
Al	.0040	.0098	0.10	0.25		
b	.013	.020	0.33	0.51		
С	.0075	.0098	0.19	0.25		
D	.189	.1968	4.80	5.00		
Е	.1497	.1574	3.80	4.00		
е	.050 BASIC		1.27 BASIC			
еl	.025 BASIC		0.635 E	BASIC		
Н	.2284	.2440	5.80	6.20		
K	.0099	.0196	0.25	0.50		
L	.016	.050	0.40	1.27		
У	0°	8°	0°	8°		



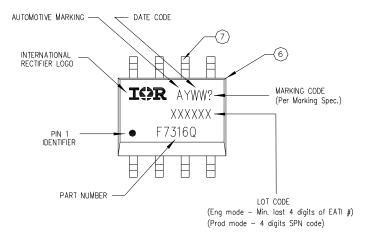


NOTES:

- 1. DIMENSIONING & TOLERANCING PER ASME Y14.5M-1994.
- 2. CONTROLLING DIMENSION: MILLIMETER
- 3. DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).
- 4. OUTLINE CONFORMS TO JEDEC OUTLINE MS-012AA.
- (5) DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.15 (.006).
- (6) DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.25 (.010).
- (7) DIMENSION IS THE LENGTH OF LEAD FOR SOLDERING TO A SUBSTRATE.



SO-8 Part Marking



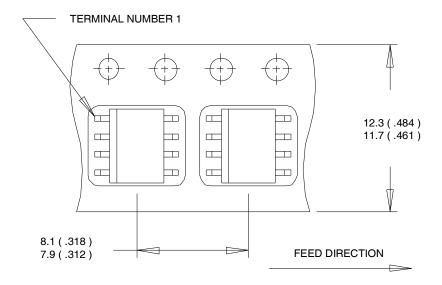
TOP MARKING (LASER)

Note: For the most current drawing please refer to IR website at http://www.irf.com/package/



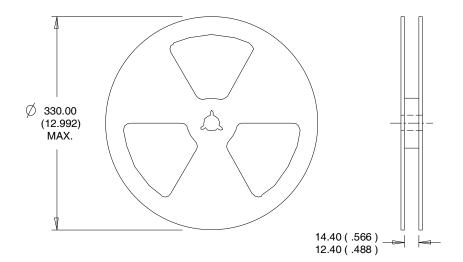
SO-8 Tape and Reel

Dimensions are shown in millimeters (inches)



NOTES:

- 1. CONTROLLING DIMENSION: MILLIMETER.
- 2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS(INCHES).
- 3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



NOTES:

- 1. CONTROLLING DIMENSION: MILLIMETER.
- 2. OUTLINE CONFORMS TO EIA-481 & EIA-541.

Note: For the most current drawing please refer to IR website at http://www.irf.com/package/



Qualification Information[†]

Qualification Level		Automotive (per AEC-Q101) ††				
		Comments: This part number(s) passed Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.				
Moisture Sensitivity Level		SO-8	MSL1			
Machine Model Human Body Model		Class M2(+/- 200V) ^{†††} (per AEC-Q101-002)				
		Class H1A(+/- 500V) ^{†††} (per AEC-Q101-001)				
	Charged Device Model	Class C5(+/- 2000V) ^{†††} (per AEC-Q101-005)				
RoHS Comp	RoHS Compliant		Yes			

- † Qualification standards can be found at International Rectifier's web site: http://www.irf.com/
- †† Exceptions (if any) to AEC-Q101 requirements are noted in the qualification report.
- ††† Highest passing voltage

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Revision History

Date	Comments		
	Added "Logic Level Gate Drive" bullet in the features section on page 1		
3/27/2014	Updated part marking on page 6		
	Updated data sheet with new IR corporate template		

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